

HA12187FP

Bus Interface Driver/Receiver IC

REJ03F0131-0200

(Previous: ADE-207-174A)

Rev.2.00

Jun 15, 2005

Description

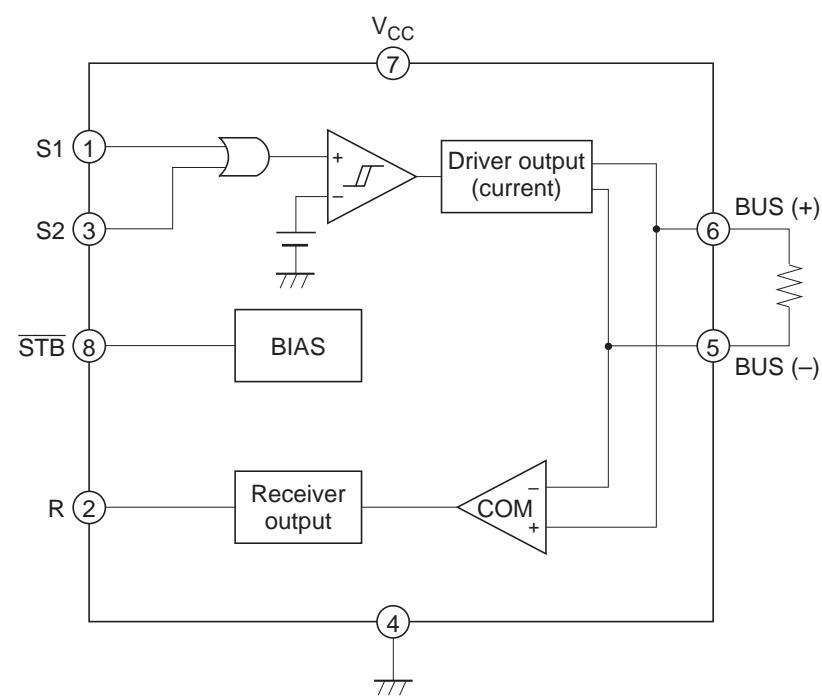
The HA12187FP was developed to be used as a bus interface driver/receiver IC in automotive audio equipment controllers. It implements a two-wire serial bus.

Functions

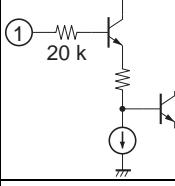
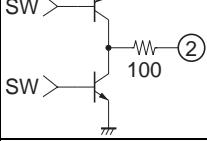
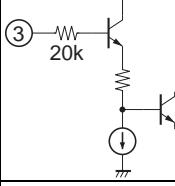
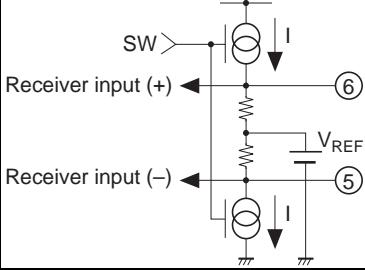
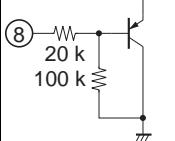
- Two-input OR circuit
- Input comparator circuit
- Current output driver circuit
- Receiver input comparator circuit
- Receiver output circuit
- Standby circuit

Features

- Supports two data inputs (Pins 1 and 3 are the input pins)
- Comparators with hysteresis characteristics were adopted for the inputs
- Current drive output drivers adopted (Output current: 3.8 mA typical)
- Comparators with hysteresis characteristics were adopted for the receivers
- Wide receiver common-mode input operating range (Common-mode input operating range: 0 to 5 V typical)
- The driver output and the receiver input can withstand high voltages (Maximum rating: 18 V)
- Standby function (The IC enters standby mode when pin 8 goes low)
- Operating power-supply voltage range: 5 V ±0.5 V

Block Diagram

Pin Functions

Pin No.	Symbol	Function	Equivalent Circuit
1	S1	Data input	
2	R out	Receiver output	
3	S2	Data input	
4	GND	GND	
5	BUS (-)	Bus output (-) Receiver input (-)	
6	BUS (+)	Bus output (+) Receiver input (+)	
7	V _{CC}	Power supply	
8	STB	Standby control input	

Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings	Unit	Notes
Power-supply voltage	V _{CC}	7	V	
Allowable power dissipation	P _d	400	mW	T _a ≤ 85°C
Operating temperature	T _{opr}	-40 to 85	°C	
Storage temperature	T _{stg}	-55 to 125	°C	
Input voltage	V _{in}	-1.0 to 6.7	V	
Bus input voltage	Bus	18	V	

Note: Recommended operating power supply voltage range: 5 V ±0.5 V

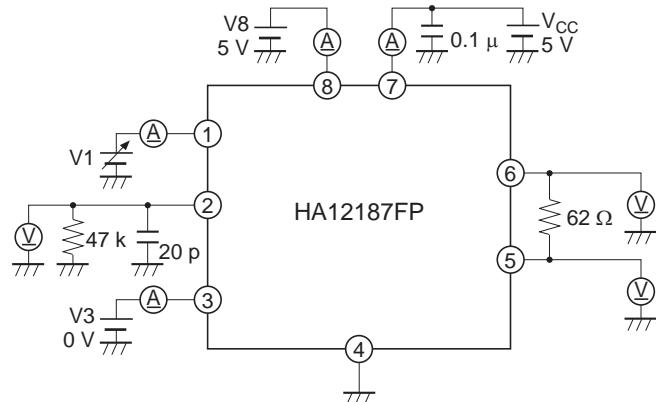
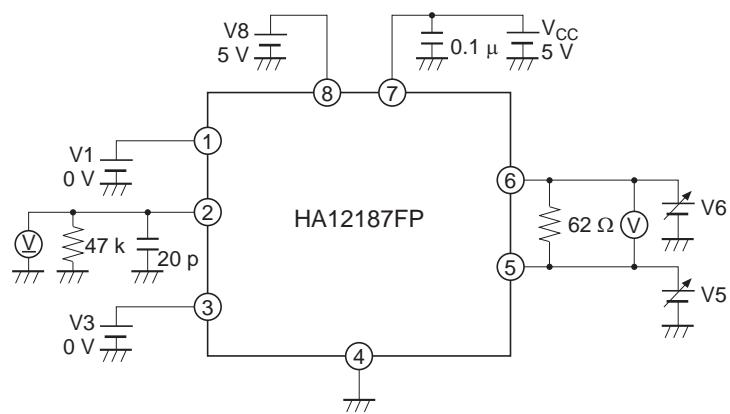
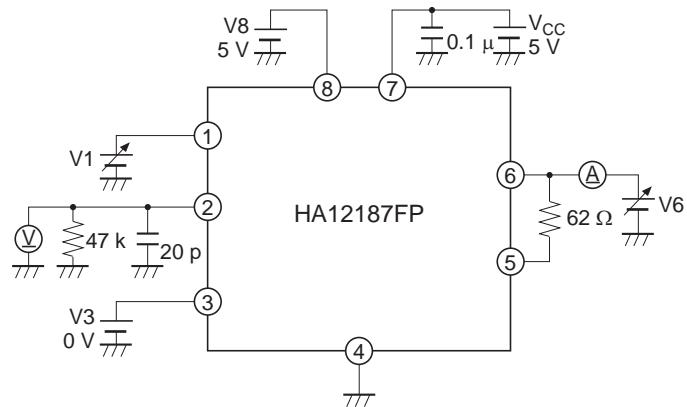
Electrical Characteristics(V_{CC} = 5.0 V, Ta = 25°C)

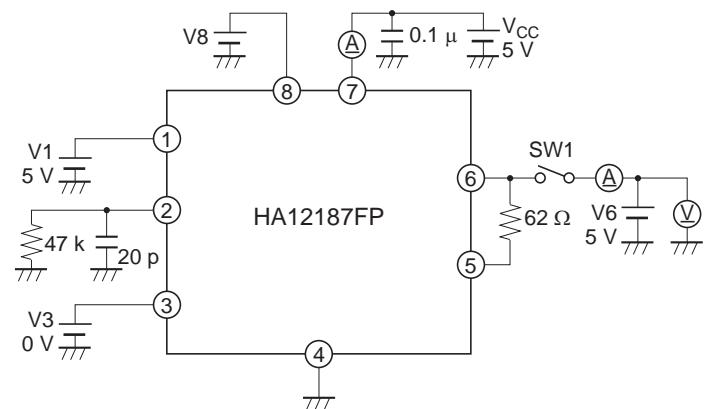
Item	Symbol	Min	Typ	Max	Unit	Test Conditions	Test Pin	Test Circuit	
S1	High-level input voltage	V _{IHS1}	3.5	—	V	V1 = 0 V → 5 V, V3 = 0 V With the potential difference between pin 5 and pin 6 120 mV or more	1	Figure 1	
	Low-level input voltage	V _{ILS1}	—	—	1.5	V	V1 = 5 V → 0 V, V3 = 0 V With the potential difference between pin 5 and pin 6 20 mV or less	1	
	High-level input current	I _{IHS1}	—	—	1	μA	V1 = 5 V, V3 = 0 V	1	
	Low-level input current	I _{ILS1}	—	—	1	μA	V1 = 0 V, V3 = 0 V	1	
S2	High-level input voltage	V _{IHS2}	3.5	—	—	V	V3 = 0 V → 5 V, V1 = 0 V With the potential difference between pin 5 and pin 6 120 mV or more	3	Figure 1
	Low-level input voltage	V _{ILS2}	—	—	1.5	V	V3 = 5 V → 0 V, V1 = 0 V With the potential difference between pin 5 and pin 6 20 mV or less	3	
	High-level input current	I _{IHS2}	—	—	1	μA	V1 = 0 V, V3 = 5 V	3	
	Low-level input current	I _{ILS2}	—	—	1	μA	V1 = 0 V, V3 = 0 V	3	
Driver	High-level output current	I _{OH}	3.0	3.8	4.8	mA	I _{OH} = V _{OHD+} - V _{OHD-} / 62 Ω	5, 6	Figure 1
	Low-level output leakage current	I _{OL}	—	—	1	μA	Pin 5 voltage = V _{OP-} I _{OL} = V _{OP+} - V _{OP-} / R _l	5, 6	
	Reference operating voltage (+)	V _{OP+}	2.3	2.5	2.7	V	V1 = 0 V, V3 = 0 V	6	
	Reference operating voltage (-)	V _{OP-}	2.3	2.5	2.7	V	V1 = 0 V, V3 = 0 V	5	
Current drain 1	I _{ccH}	5.5	7.3	9.5	mA	V1 = 5 V, V3 = 0 V	7	Figure 1	
Current drain 2	I _{ccL}	1.7	2.2	2.7	mA	V1 = 0 V, V3 = 0 V	7	Figure 1	

Electrical Characteristics (cont.)(V_{CC} = 5.0 V, Ta = 25°C)

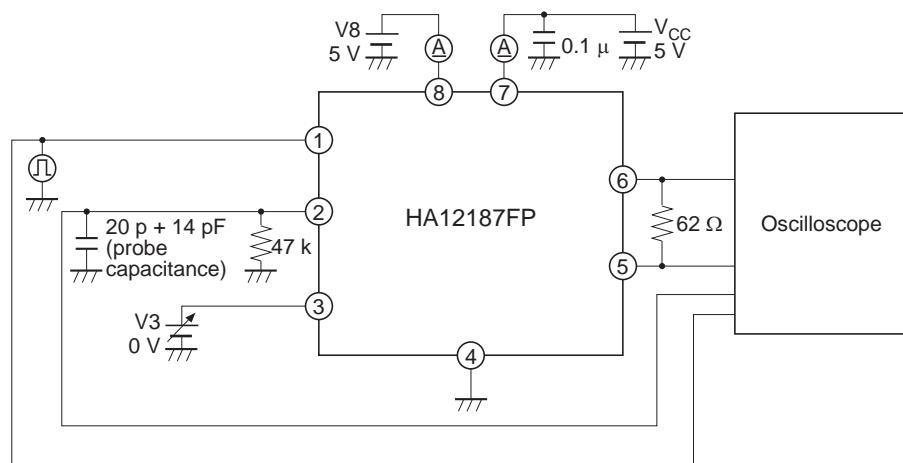
Item		Symbol	Min	Typ	Max	Unit	Test Condition	Test Pin	Test Circuit
Receiver	High-level input voltage (1)	V _{IH1}	—	80	120	mV	V6 = 0 → 5 V, pin 2 = 4 V or more, V1 = 0 V, V3 = 0 V, V5 = V _{OP-} , V _{IH1} = V6 – V5	2	Figure 2
	Low-level input voltage (1)	V _{IL1}	20	45	—	mV	V6 = 5 → 0 V, pin 2 = 1 V or less, V1 = 0 V, V3 = 0 V, V5 = V _{OP-} , V _{IL1} = V6 – V5	2	Figure 2
	Input hysteresis voltage (1)	V _{IHYS1}	10	35	60	mV	V _{IHYS1} = V _{IH1} – V _{IL1}		
	High-level common-mode input voltage	V _{IHCOM}	4.5	—	—	V	V5 = 0 → 5 V, pin 2 = 4 V or more, V1 = 0 V, V3 = 0 V, V6 – V5 = 120 mV	5	Figure 2
	Low-level common-mode input voltage	V _{ILCOM}	5	—	—	V	V5 = 0 → 5 V, pin 2 = 1 V or less, V1 = 0 V, V3 = 0 V, V6 – V5 = 20 mV	5	Figure 2
	Receiver input resistance* ¹	R _I	25	35	45	kΩ	V1 = 0 V, R _I = $\frac{0.6\text{V}}{\text{I}_1 - \text{I}_2}$	5, 6	Figure 3
	High-level output voltage	V _{OH}	4.5	—	—	V	V1 = 5 V, V3 = 0 V	2	Figure 1
	Low-level output voltage	V _{OL}	—	—	1.0	V	V1 = 0 V, V3 = 0 V	2	Figure 1
Power supply off output leakage current	I _{OLEAK}	—	—	1	μA		V _{CC} off, V8 = 0 V, V6 = 5 V, V1 = 0 V, V3 = 0 V, SW1 on	5, 6	Figure 4
STB on voltage	V _{STB} on	—	—	1.5	V		V8 = 5 → 0 V, V1 = 5 V, V8 when I _{CC} ≤ 20 μA	7	Figure 4
STB off voltage	V _{STB} off	3.5	—	—	V		V8 = 0 → 5 V, V1 = 5 V, V8 when I _{CC} ≥ 4.5 mA	7	Figure 4
Standby mode current drain	I _{CCstb}	—	10	20	μA		V1 = 5 V, V3 = 0 V, V8 = 0 V	7	Figure 4
Standby mode leakage current	I _{STB-Leak}	—	—	1	μA		V1 = 5 V, V3 = 0 V, V8 = 0 V, V6 = 5 V, SW1 on	5, 6	Figure 4
Delay time (L → H)	DLY1	—	600	800	nS		See the operating waveform figure	2	Figure 5
Delay time (H → L)	DLY2	—	450	800	nS		See the operating waveform figure	2	Figure 5

Note: 1. I₁ is the measured current when V6 = (V_{OP+}) + 0.3 V, and I₂ is the measured current when V6 = (V_{OP+}) – 0.3 V.

Test Circuits**Test Circuit 1****Test Circuit 2****Test Circuit 3**

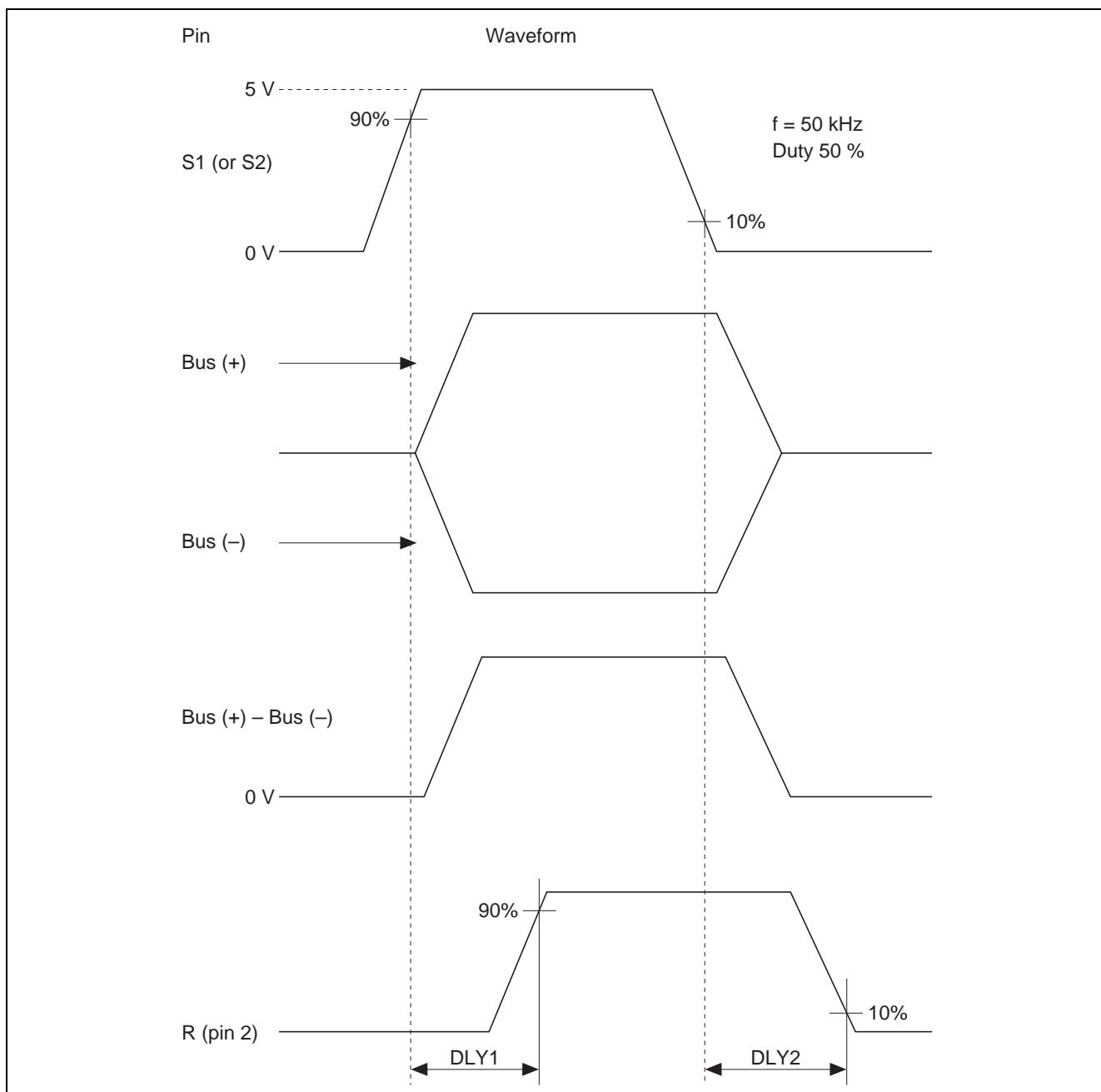


Test Circuit 4

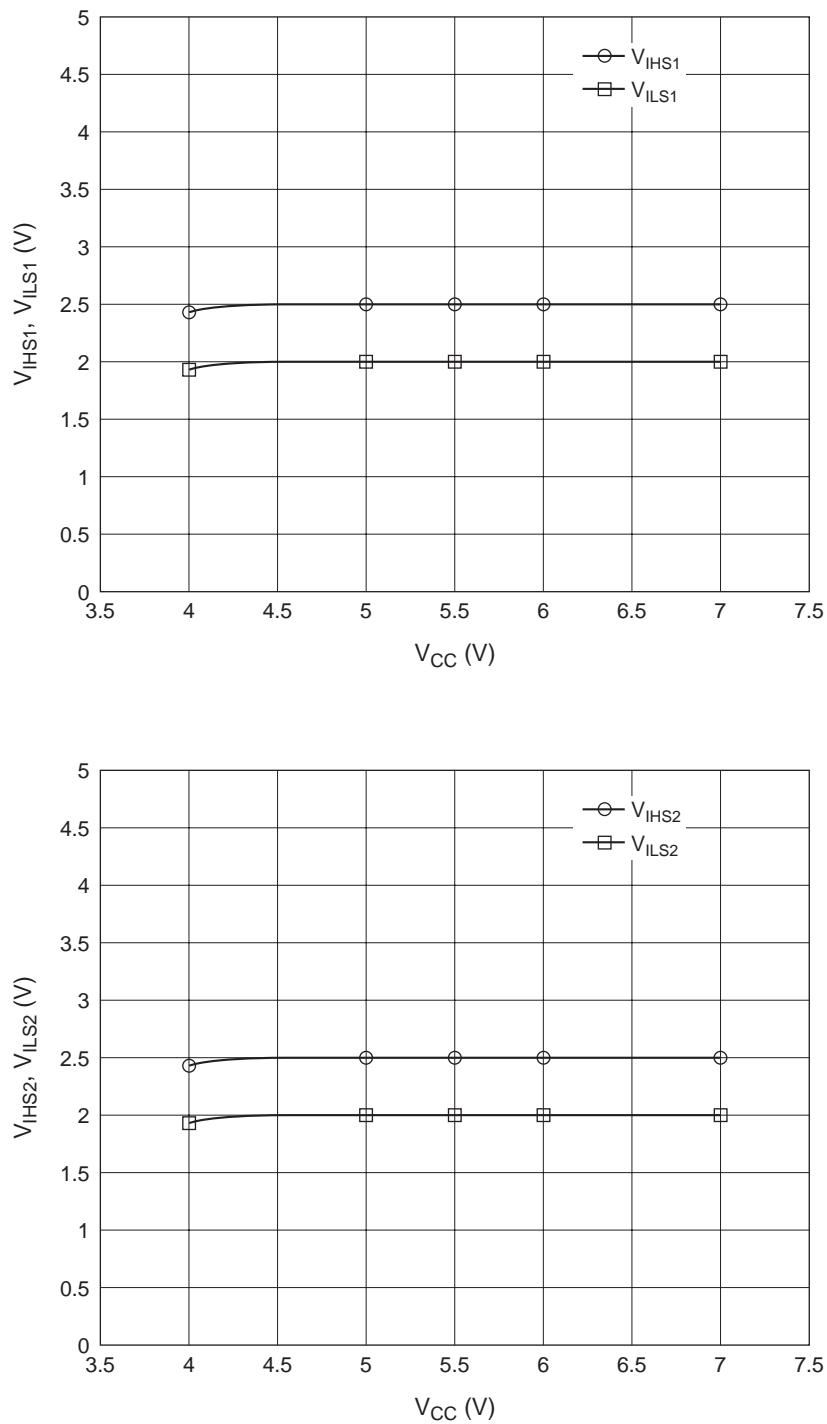


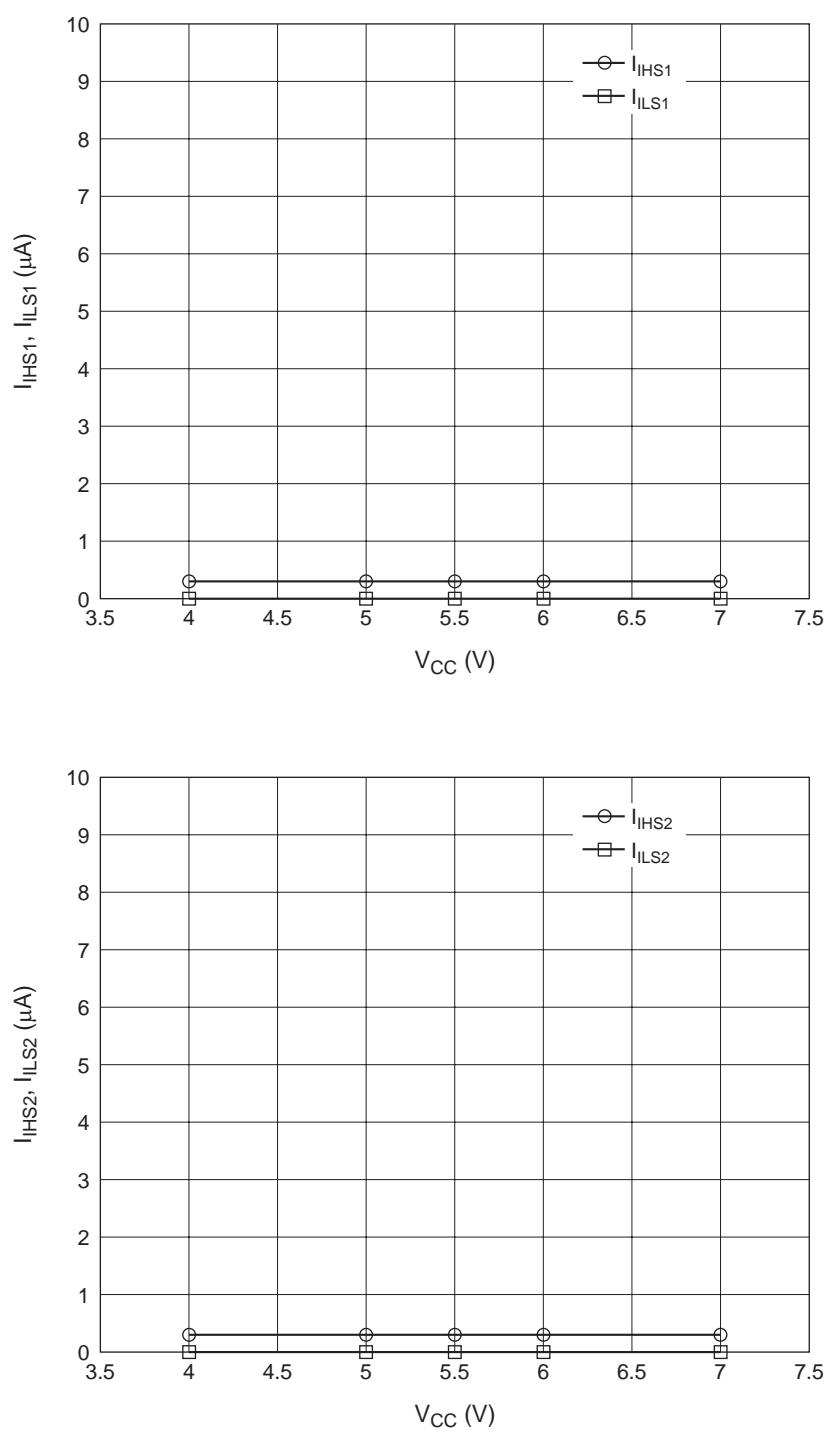
Test Circuit 5

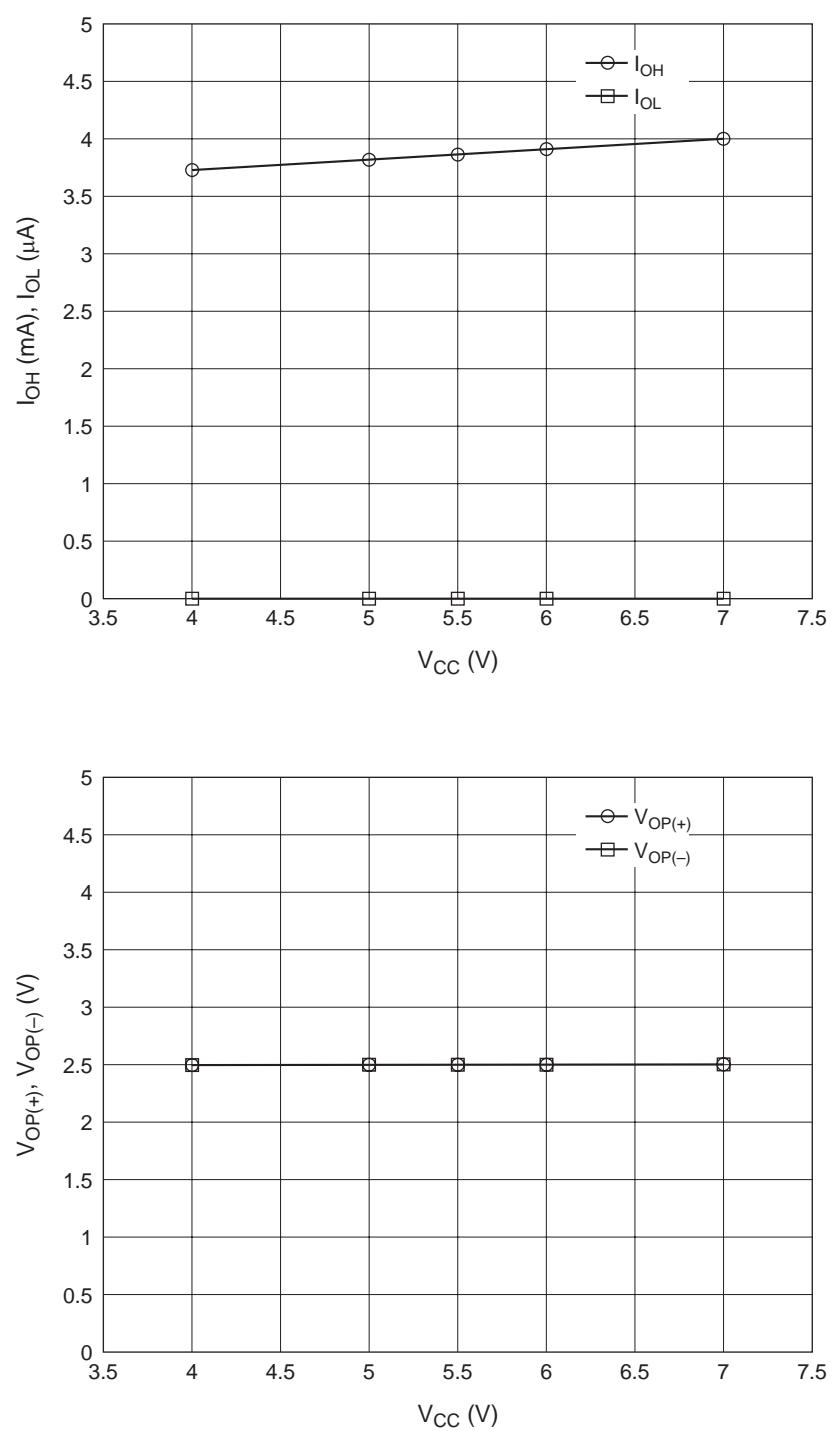
Operating Waveforms

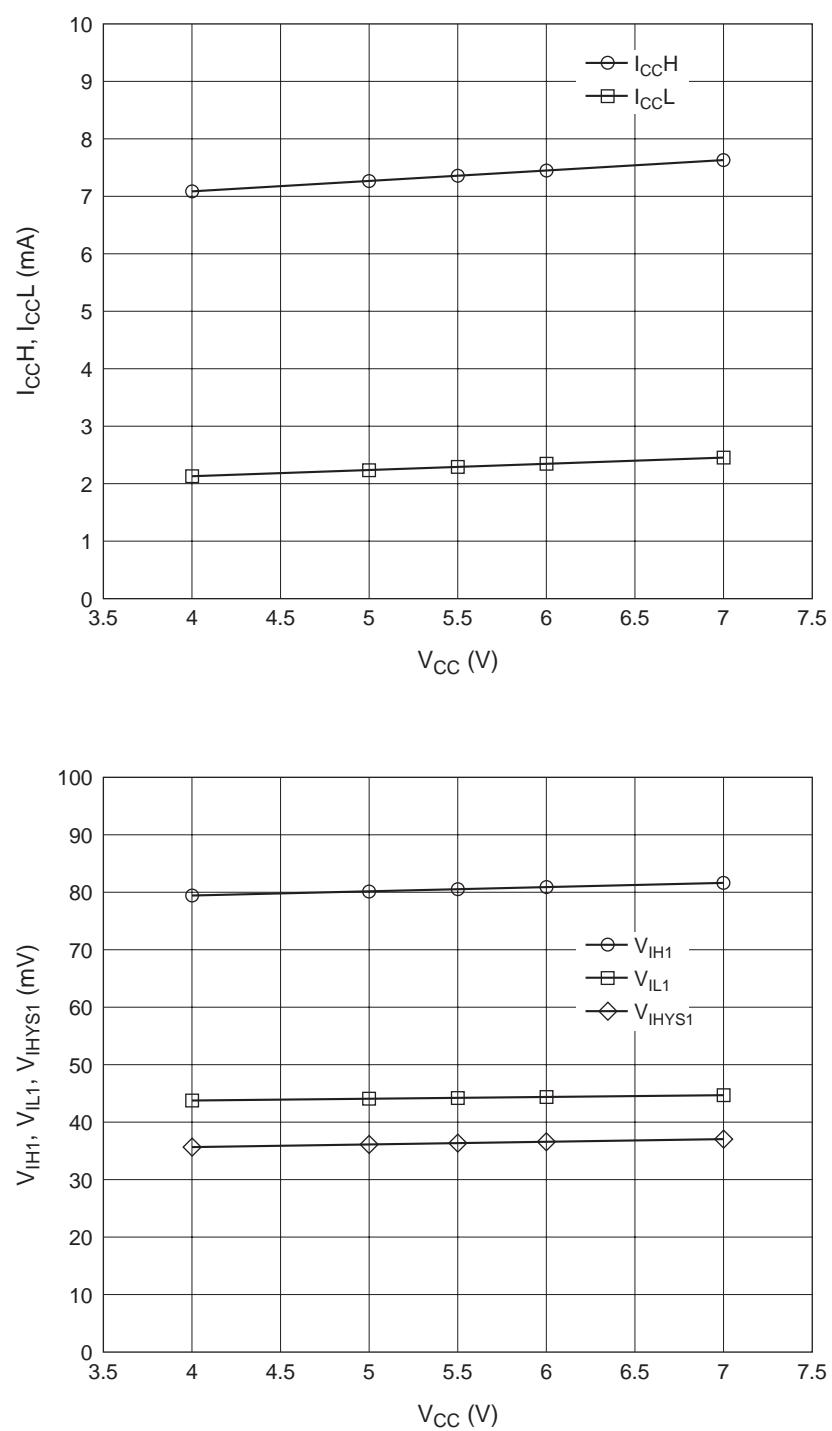


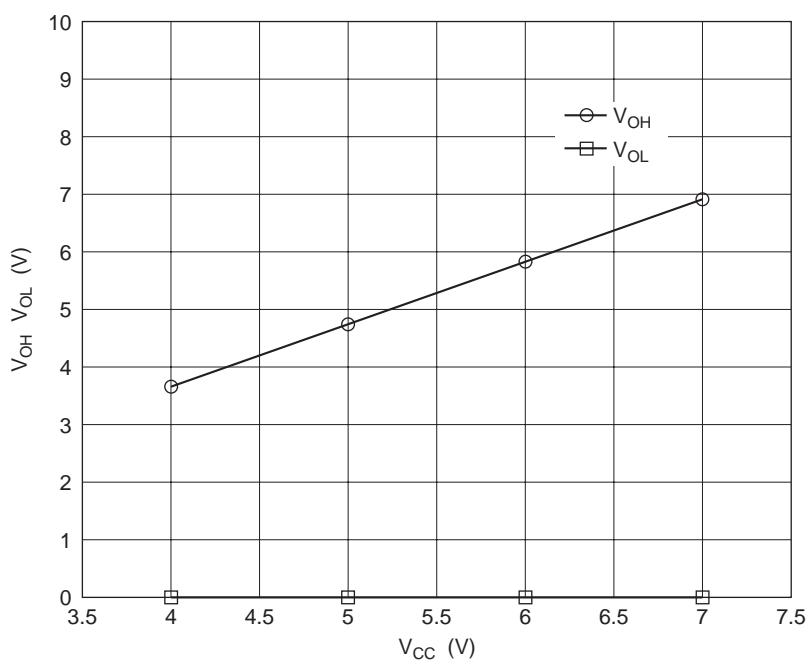
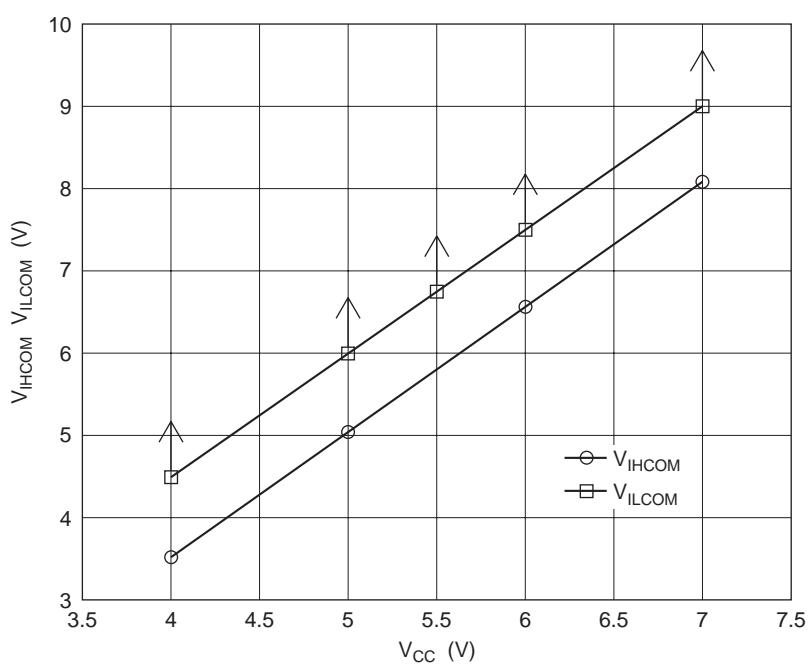
Main Characteristics

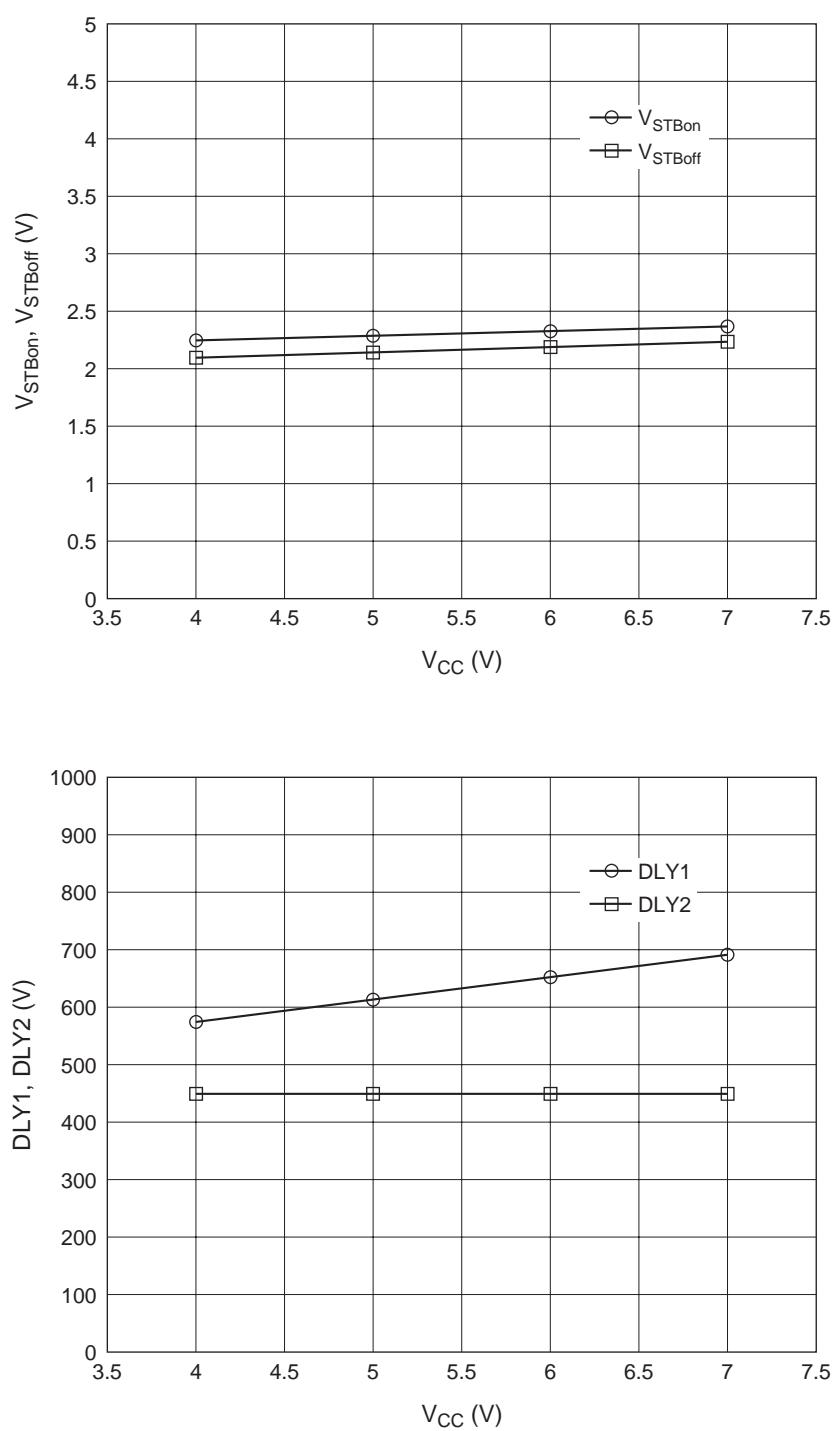


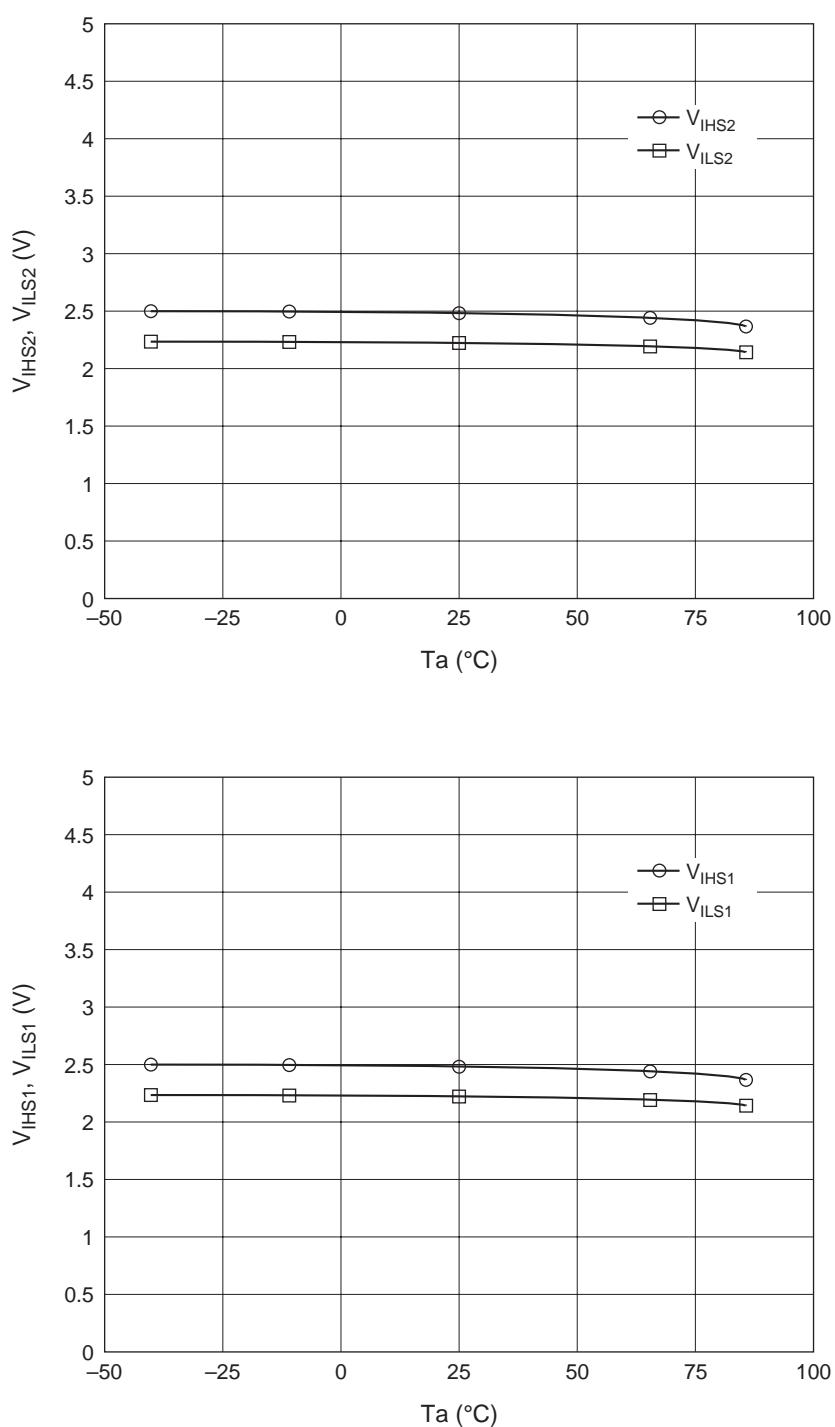


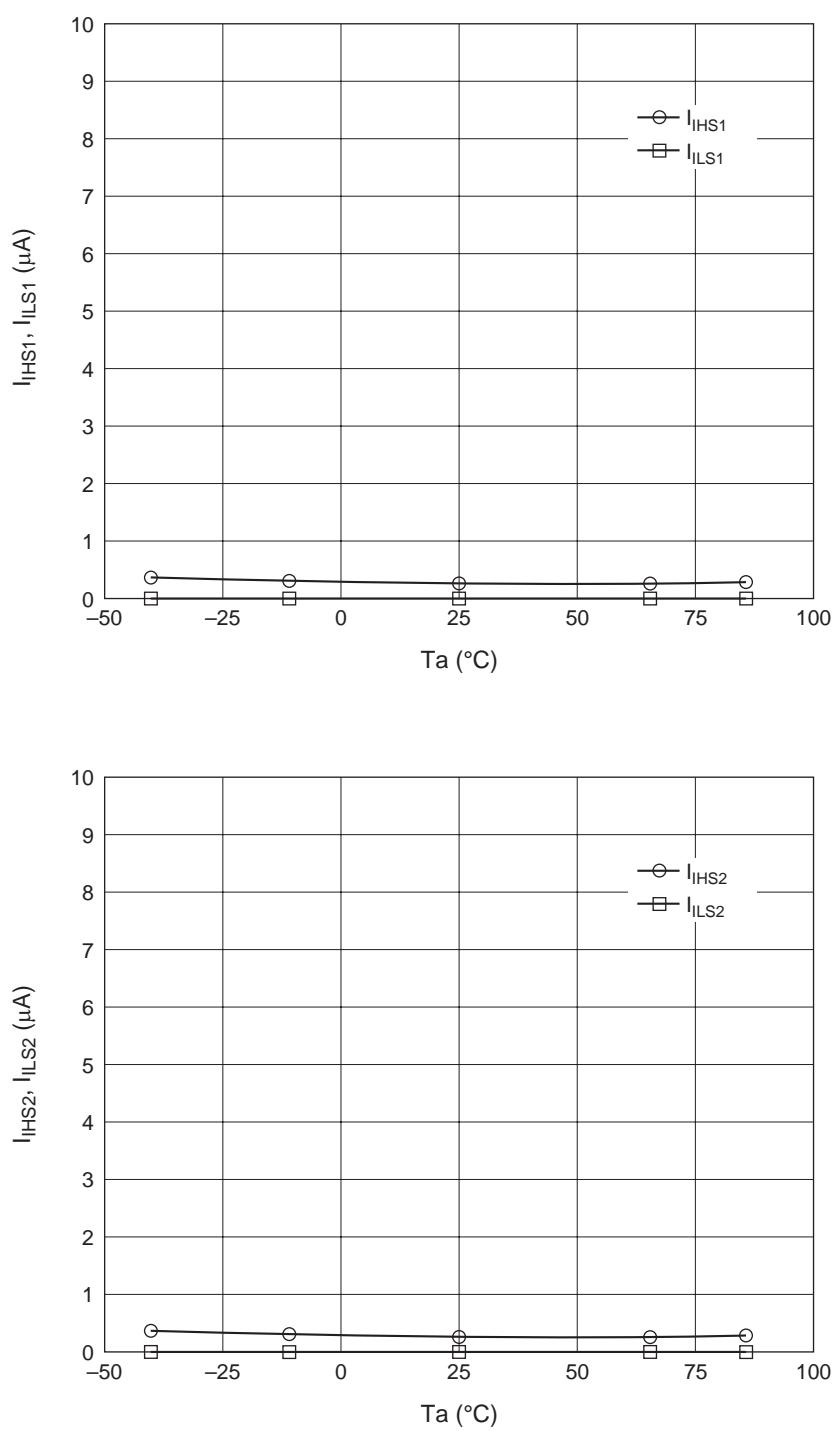


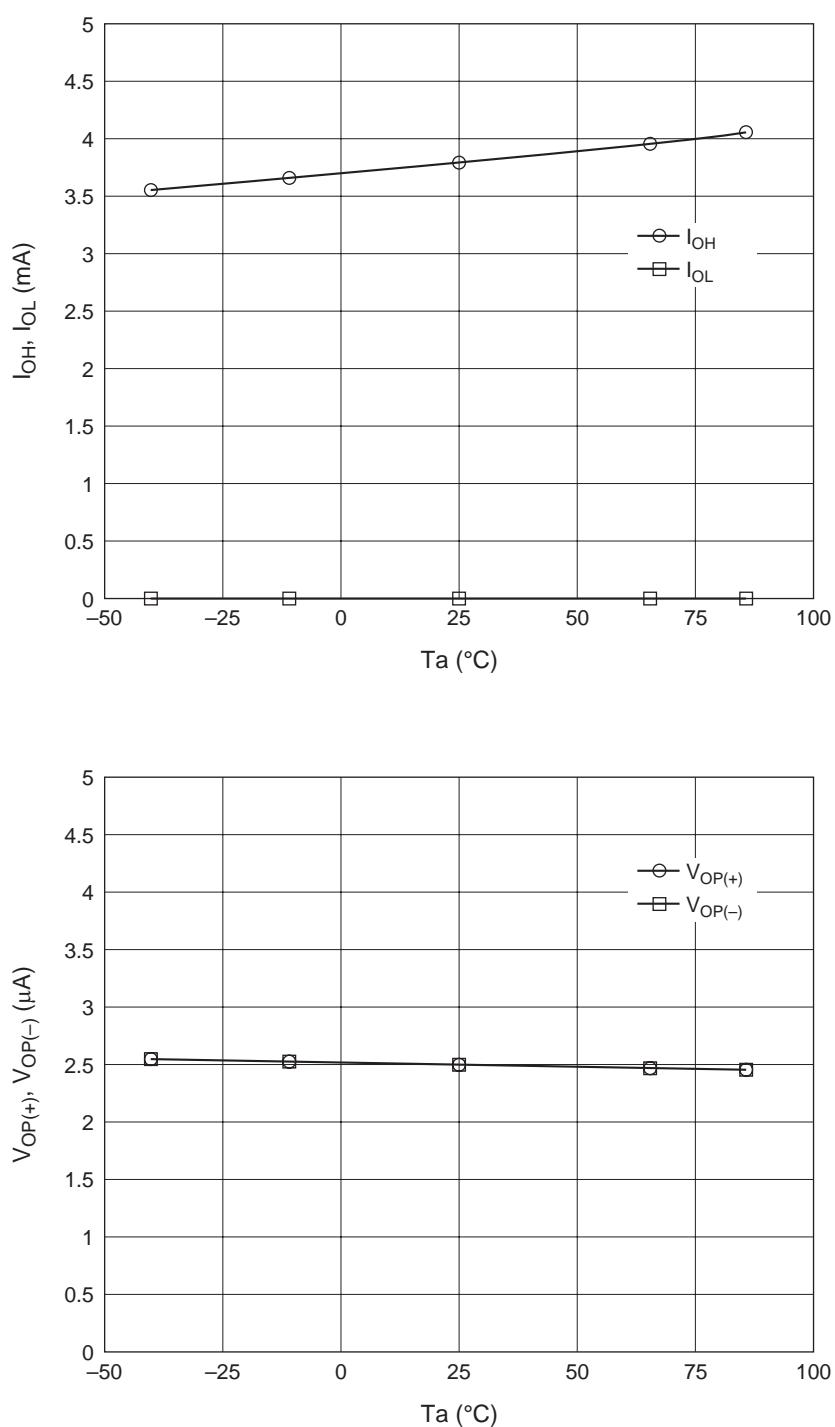


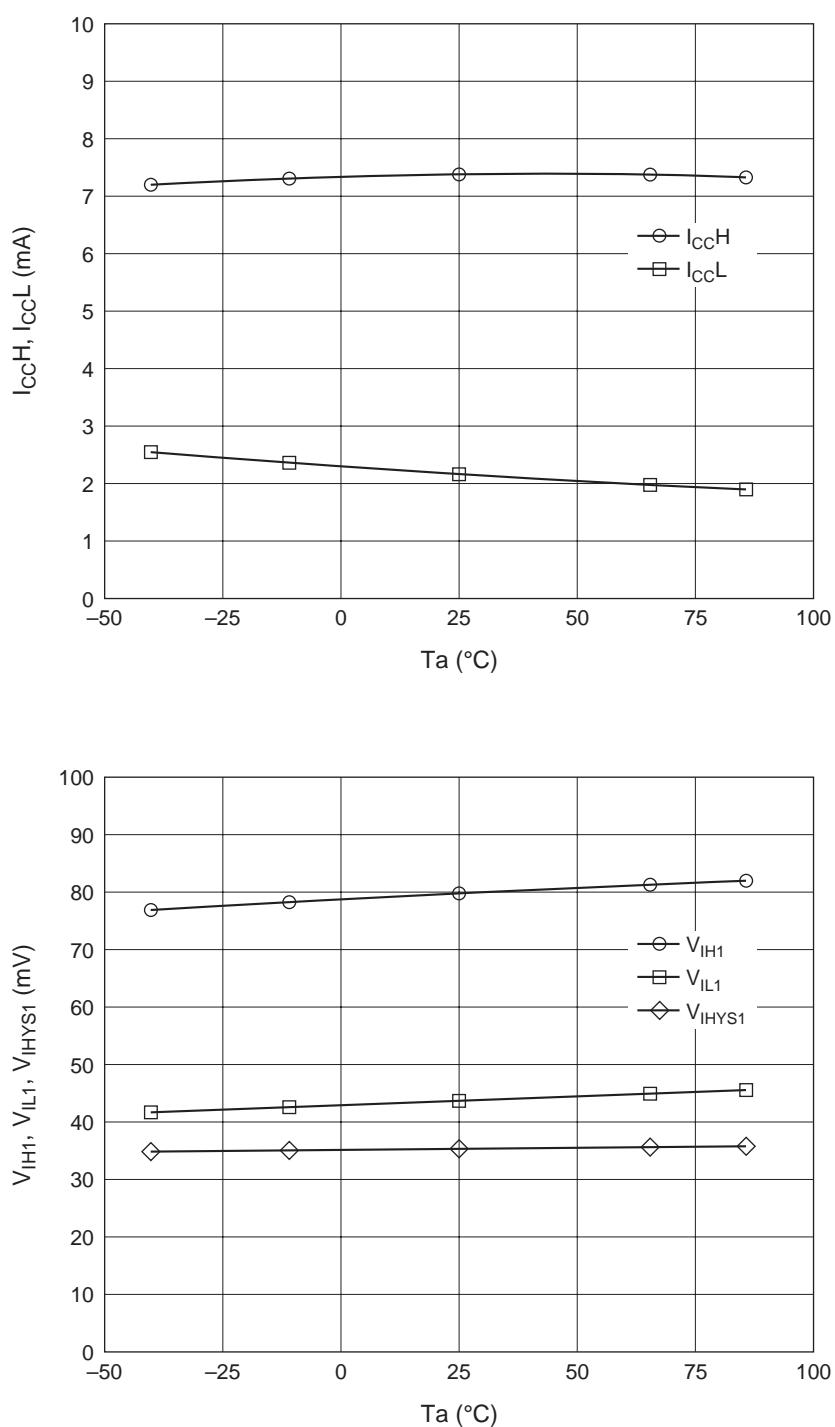


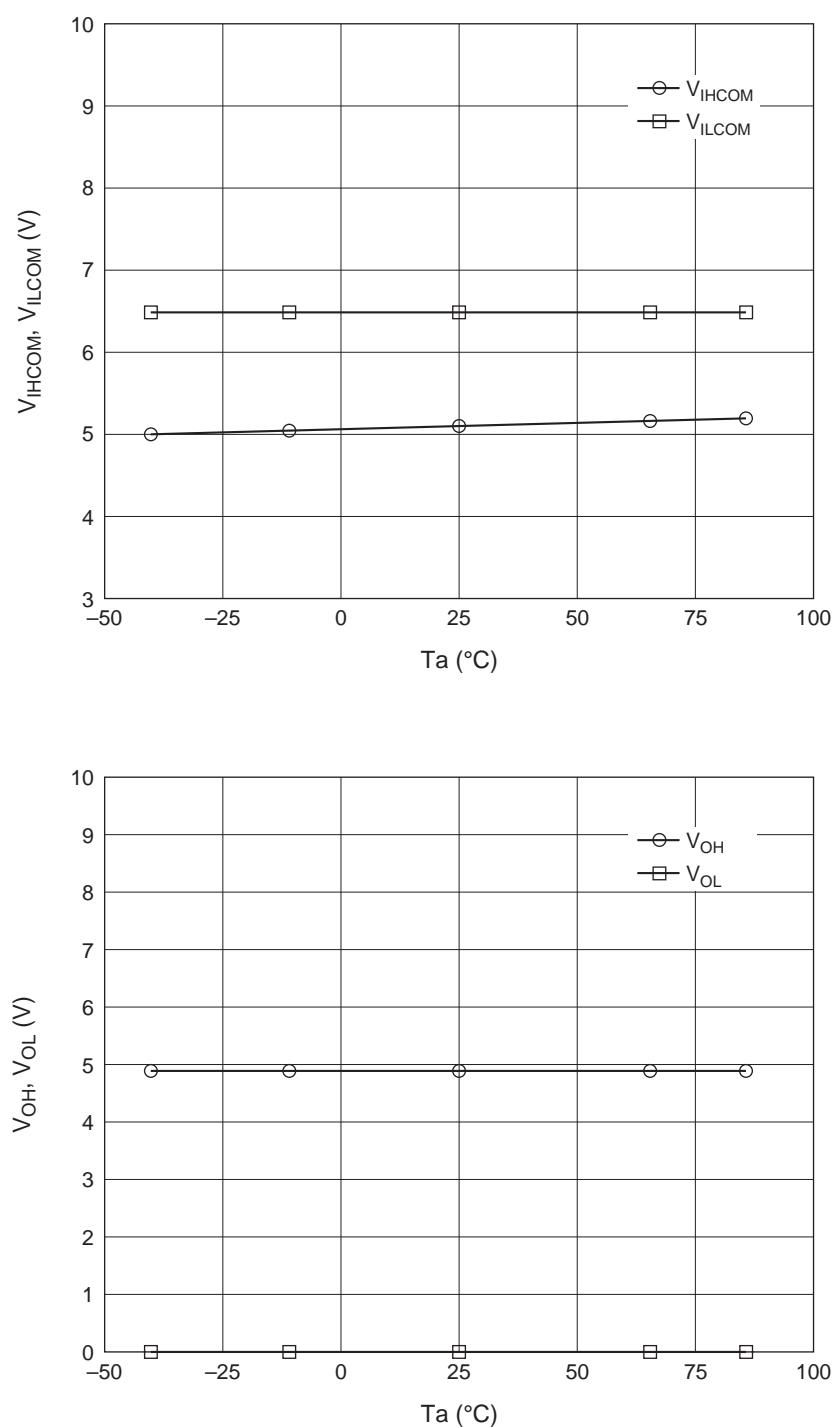


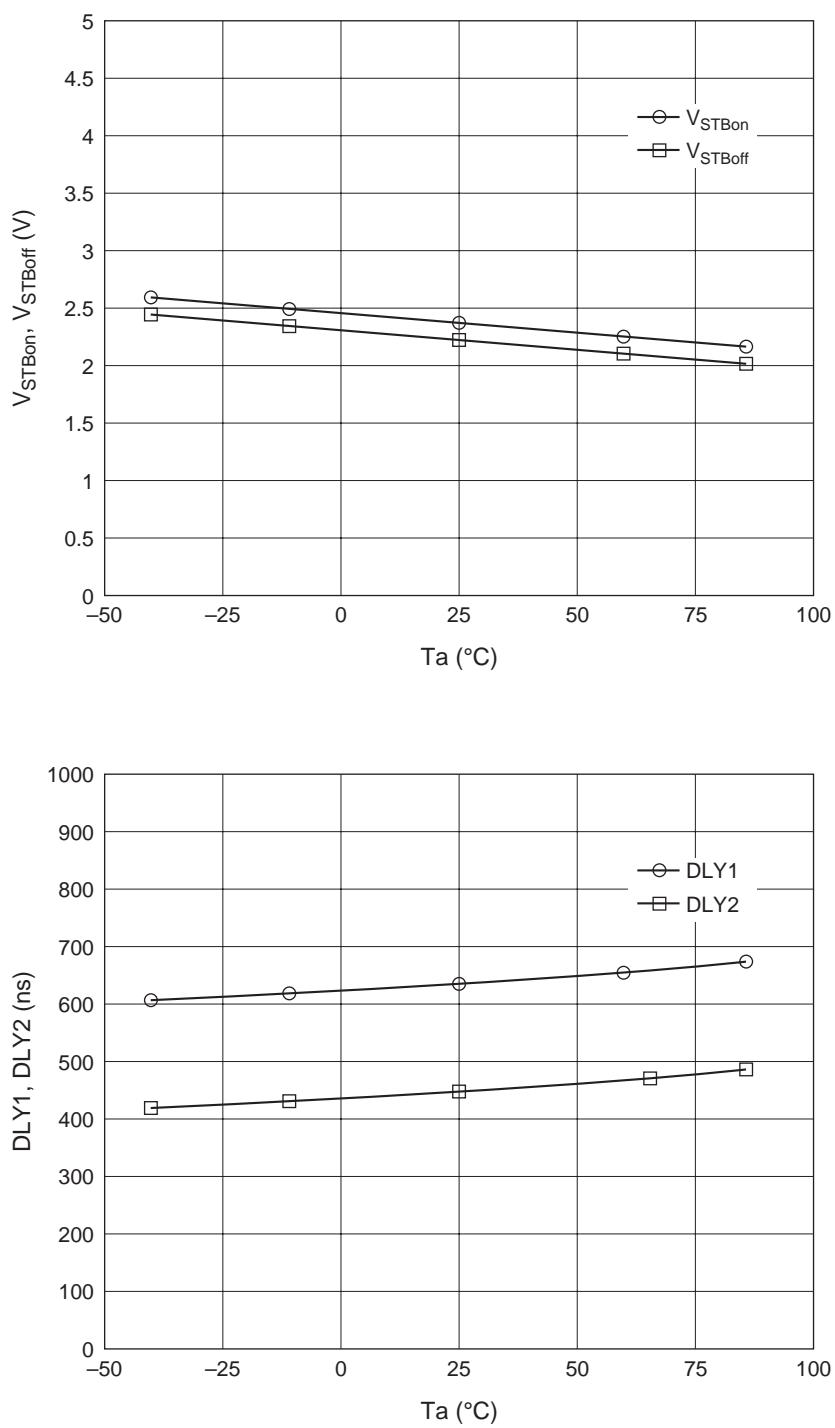




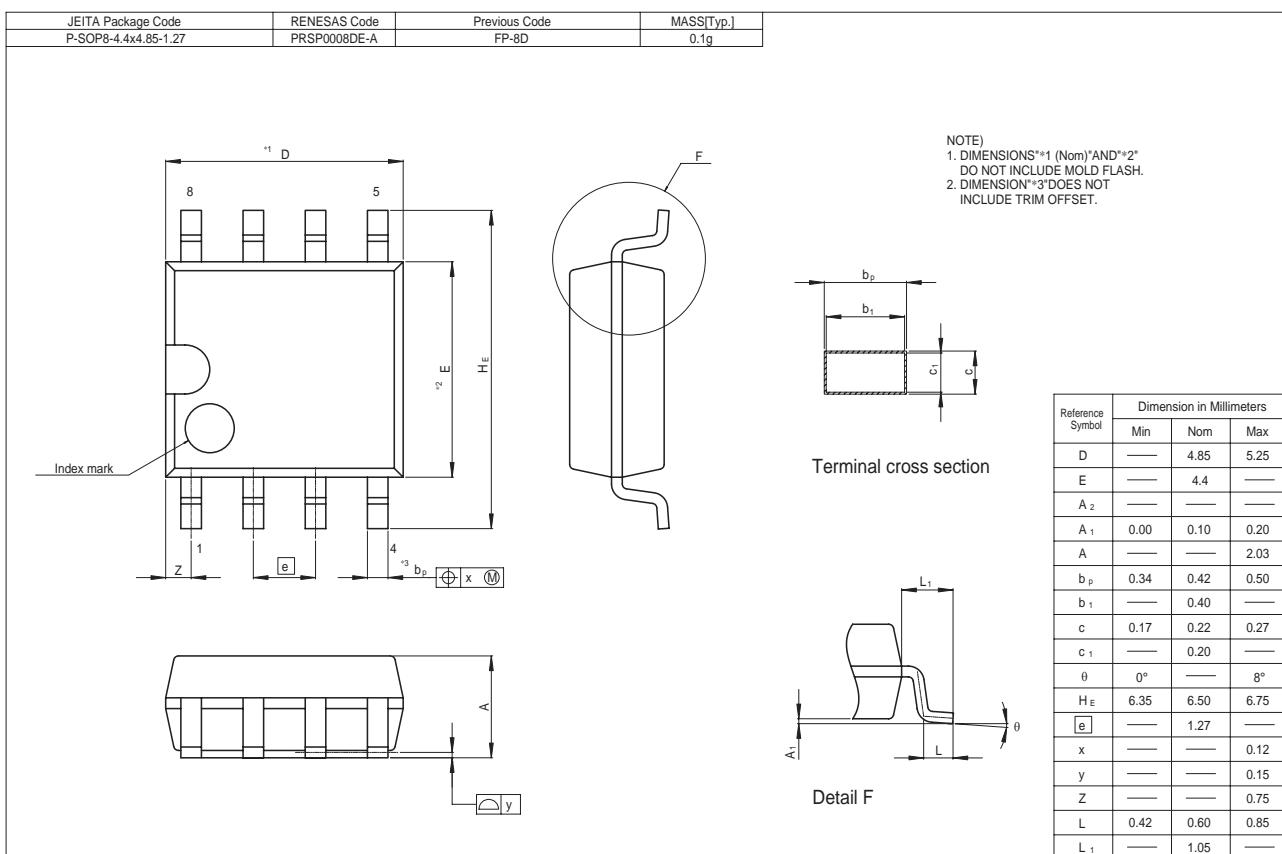








Package Dimensions



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